



COPY PAPERS
ORIGINALLY FILED

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Yasuaki Tsuchiya, et al.

Examiner: Maria Guerrero

Serial No.: 09/737,397

Art Unit: 2822

Filed: December 15, 2000

Docket: 14162

For: PROCESS FOR FORMING A
METAL INTERCONNECT

Dated: August 8, 2002

Assistant Commissioner for Patents
Washington, D.C. 20231

PATENTS

TECHNOLOGY CENTER 2800

AUG 22 2002

RECEIVED

7/Supp
Response
9-402
A. Well

SUPPLEMENTAL RESPONSE

Sir:

In furtherance of the Response dated July 26, 2002, applicants are submitting this

Supplemental Response:

REMARKS

This Response is supplemental to the Response dated on July 26, 2002; this is not meant to replace it.

Applicants are submitting herewith a verified translation of Japanese priority application, Japanese Patent Application No. 11-374487 (374487/1999), ("Japanese application") filed on December 28, 1999 in the Japanese Patent Office.

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner of Patents and Trademarks, Washington, D.C. 20231 on August 8, 2002.

Dated: August 8, 2002


Michelle Mustafa